#### 4.0x4.0mm RIGHT ANGLE SURFACE MOUNT LED LAMP

Part Number: KA-4040ZGCT

-4040ZG

Green



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

#### Features

- Single color.
- Suitable for all SMT assembly and solder process.
- Available on tape and reel.
- Ideal for backlighting.
- Package : 500pcs / reel.
- Moisture sensitivity level : level 4.
- RoHS compliant.

#### Description

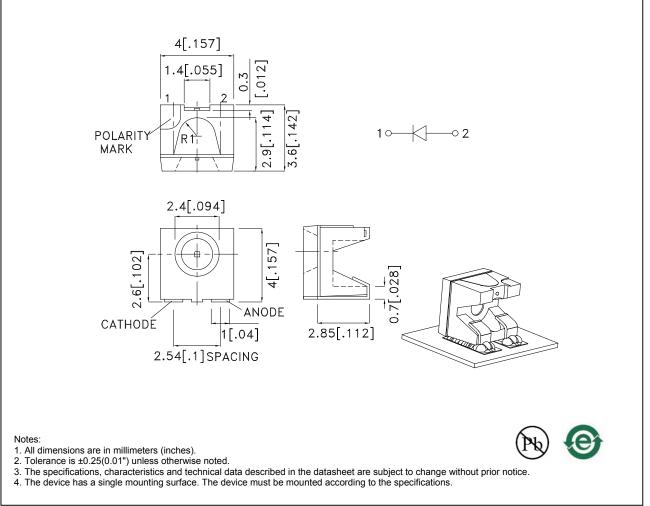
The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

#### **Package Dimensions**



SPEC NO: DSAJ9308 APPROVED: WYNEC REV NO: V.3 CHECKED: Allen Liu DATE: OCT/06/2010 DRAWN: J.Yu PAGE: 1 OF 5 ERP: 1201004478

#### Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KA-4040ZGCT	Green (InGaN)	WATER CLEAR	400	800	90°

Notes:

θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
Luminous intensity/ luminous Flux: +/-15%.

#### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	515		nm	I⊧=20mA
λD [1]	Dominant Wavelength	Green	525		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	Green	30		nm	IF=20mA
С	Capacitance	Green	45		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.3	4.1	V	I⊧=20mA
IR	Reverse Current	Green		50	uA	VR=5V

Notes:

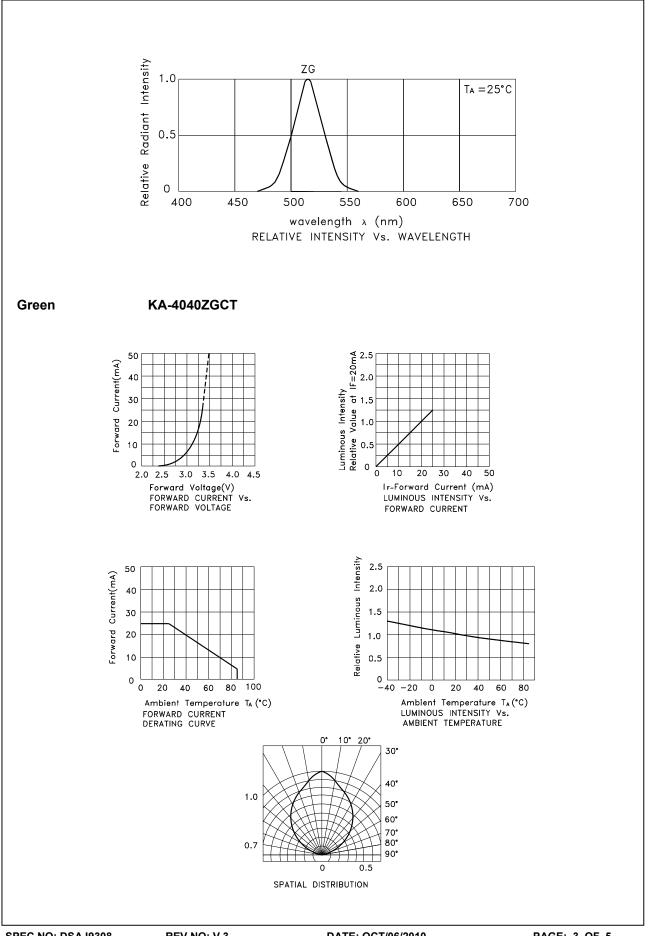
1.Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

#### Absolute Maximum Ratings at TA=25°C

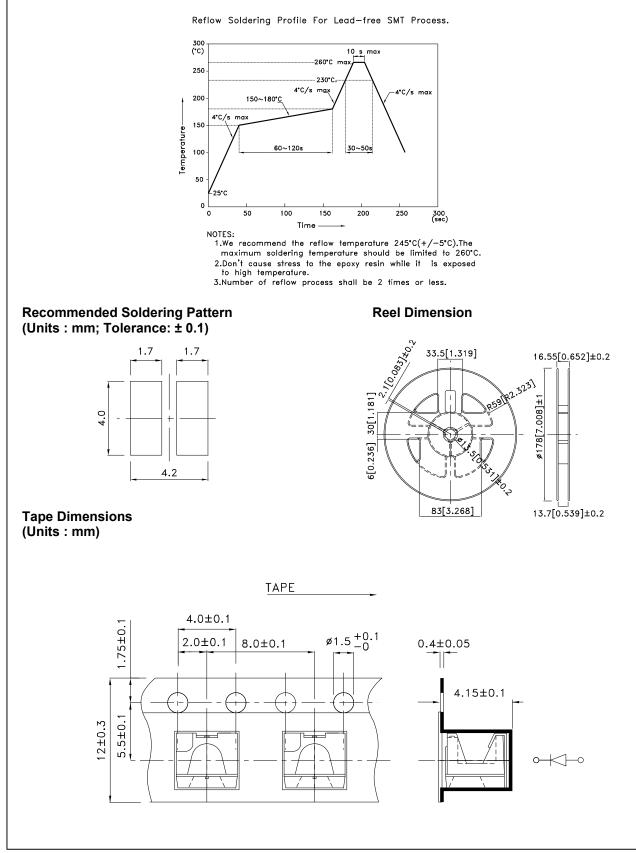
Parameter	Green	Units	
Power dissipation	102.5	mW	
DC Forward Current	25	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.



### KA-4040ZGCT

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.



DATE: OCT/06/2010 DRAWN: J.Yu

